

**PCN# 20210816001.1A**  
**Qualification of TI Malaysia as a New**  
**Assembly site for select devices**  
**Change Notification / Sample Request**

**Date:** December 17, 2021  
**To:** MOUSER PCN

Dear Customer:

**Revision A** is to announce the addition of a new device that was not included on the original PCN notification.

This is an announcement of a change to a device that is currently offered by Texas Instruments. The details of this change are on the following pages.

Texas Instruments requires acknowledgement of receipt of this notification within **30** days of the date of this notice. Lack of acknowledgement of this notice within 30 days constitutes acceptance of the change. If samples or additional data are required, requests must be received within **30 days** of this notification.

The changes discussed within this PCN will not take effect any earlier than the proposed first ship date on Page 3 of this notification, unless customer agreement has been reached on an earlier implementation of the change.

This notice does not change the end-of-life status of any product. Should product affected be on a previously issued product withdrawal/discontinuance notice, this notification does not extend the life of that product or change the life time buy offering/discontinuance plan.

For questions regarding this notice or to provide acknowledgement of this PCN, you may contact your local Field Sales Representative or the PCN Team ([PCN\\_ww\\_admin\\_team@list.ti.com](mailto:PCN_ww_admin_team@list.ti.com)). For sample requests or sample related questions, contact your local Field Sales Representative.

Sincerely,

PCN Team  
SC Business Services

**20210816001.1A**  
**Attachment: 1**

**Products Affected:**

The devices listed on this page are a subset of the complete list of affected devices. According to our records, these are the devices that you have purchased within the past twenty-four (24) months. The corresponding customer part number is also listed, if available.

<b>DEVICE</b>	<b>CUSTOMER PART NUMBER</b>
DS3668N/NOPB	null

Technical details of this Product Change follow on the next page(s).

<b>PCN Number:</b>	20210816001.1A	<b>PCN Date:</b>	December 17, 2021
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<b>Title:</b>	Qualification of TI Malaysia as a new Assembly site for select devices		
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<b>Customer Contact:</b>	<a href="#">PCN Manager</a>	<b>Dept:</b>	Quality Services
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<b>Proposed 1<sup>st</sup> Ship Date:</b>	Nov 19, 2021	<b>Estimated Sample Availability:</b>	Date Provided at Sample request
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<b>Change Type:</b>			
<input checked="" type="checkbox"/>	Assembly Site	<input type="checkbox"/>	Design
<input type="checkbox"/>	Assembly Process	<input type="checkbox"/>	Data Sheet
<input checked="" type="checkbox"/>	Assembly Materials	<input type="checkbox"/>	Part number change
<input type="checkbox"/>	Mechanical Specification	<input type="checkbox"/>	Test Site
<input checked="" type="checkbox"/>	Packing/Shipping/Labeling	<input type="checkbox"/>	Test Process
		<input type="checkbox"/>	Wafer Bump Site
		<input type="checkbox"/>	Wafer Bump Material
		<input type="checkbox"/>	Wafer Bump Process
		<input type="checkbox"/>	Wafer Fab Site
		<input type="checkbox"/>	Wafer Fab Materials
		<input type="checkbox"/>	Wafer Fab Process

### PCN Details

#### Description of Change:

**Revision A** is to announce the addition of DS3668N/NOPB device that was not included on the original PCN notification. The new device is highlighted and **bolded** in the device list below. The expected first shipment date for the new device will be 90 days from this notice (Mar. 17, 2022) for the newly added device only. The proposed 1<sup>st</sup> ship date of Nov 19, 2021 still applies for the original set of devices.

Texas Instruments Incorporated is announcing the qualification TIM (TI Malaysia) as a new Assembly Site for select devices listed in the "Product Affected" Section. Current assembly sites and Material differences are as follows.

Assembly Site	Assembly Site Origin	Assembly Country Code	Assembly Site City
Amkor Phil	AKR	PHL	Muntinlupa City
TI Melaka	CU6	MYS	Melaka
<a href="#">TI Malaysia</a>	<a href="#">MLA</a>	<a href="#">MYS</a>	<a href="#">Kuala Lumpur</a>


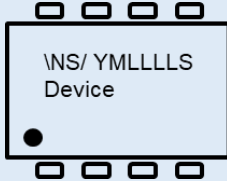
#### Group 1 Material Differences:


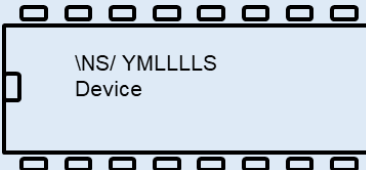
	Amkor Phil	TI Malaysia
Mount compound	101300929	<b>4147858</b>
Mold compound	101402556	<b>4211880</b>
Wire Type	Au	<b>Cu</b>
Lead Finish	Matte Sn	<b>NiPdAu</b>

#### Group 2 Material Differences:

	TI Melaka	TI Malaysia
Mount compound	210003	<b>4147858</b>
Mold compound	150044	<b>4211880</b>
Wire Type	Au	<b>Cu</b>
Lead Finish	Matte Sn	<b>NiPdAu</b>

**Package Marking Differences:**

	AMKOR /TI Melaka	TI Malaysia
<b>8 pin</b>	 <p>\NS/ = NATIONAL LOGO                      YM = YEAR MONTH DATE CODE                      L L L L = ASSY DATE CODE                      E0 = ECAT VALUE</p>	 <p>\NS/ = NATIONAL LOGO                      YM = YEAR MONTH DATE CODE                      L L L L = ASSY DATE COD                      S = ASSLY SITE CODE</p>

	AMKOR /TI Melaka	TI Malaysia
<b>14/16 pin</b>	 <p>\NS/ = NATIONAL LOGO                      YM = YEAR MONTH DATE CODE                      L L L L = ASSY DATE CODE                      P = PRIMARY ASSY SITE CODE                      G3 = ECAT VALUE</p>	 <p>\NS/ = NATIONAL LOGO                      YM = YEAR MONTH DATE CODE                      L L L L = ASSY DATE COD                      S = ASSLY SITE CODE</p>

**Reason for Change:**

Continuity of supply.

**Anticipated impact on Form, Fit, Function, Quality or Reliability (positive / negative):**

None

**Impact on Environmental Ratings**

Checked boxes indicate the status of environmental ratings following implementation of this change. If below boxes are checked, there are no changes to the associated environmental ratings.

RoHS	REACH	Green Status	IEC 62474
<input checked="" type="checkbox"/> No Change	<input checked="" type="checkbox"/> No Change	<input checked="" type="checkbox"/> No Change	<input checked="" type="checkbox"/> No Change

**Changes to product identification resulting from this PCN:**

Assembly Site		
Amkor Phil	Assembly Site Origin (22L)	ASO: AKR
TI Melaka	Assembly Site Origin (22L)	ASO: CU6
TI Malaysia	Assembly Site Origin (22L)	ASO: MLA

Sample product shipping label (not actual product label)





MADE IN: Malaysia  
 2DC: 2Q:  
 MSL 2 / 260C / 1 YEAR SEAL DT  
 MSL 1 / 235C / UNLIM 03/29/04  
 OPT:  
 ITEM: 39  
**LBL: 5A (L)TO:1750**

(1P) SN74LS07NSR  
 (Q) 2000 (D) 0336  
 (31T) LOT: 3959047MLA  
 (4W) TKY (1T) 7523483SI2  
 (P)  
 (2P) REV: (V) 0033317  
 (20L) CSO: SHE (21L) CCO:USA  
 (22L) ASO: MLA (23L) ACO: MYS

**Group 1 Product Affected:**

ADC0831CCN/NOPB	LM2574N-ADJ/NOPB	LM318N/NOPB	LMC6042IN/NOPB
ADC0832CCN/NOPB	LM2578AN/NOPB	LM319N/NOPB	LMC6044IN/NOPB
ADC0834CCN/NOPB	LM2671N-5.0/NOPB	LM324AN/NOPB	LMC6462AIN/NOPB
DS14C89AN/NOPB	LM2671N-ADJ/NOPB	LM339N/NOPB	LMC6462BIN/NOPB
LF353N/NOPB	LM2672N-12/NOPB	LM3578AN/NOPB	LMC6464BIN/NOPB
LF398AN/NOPB	LM2672N-5.0/NOPB	LM358N/NOPB	LMC6482AIN/NOPB
LF398N/NOPB	LM2672N-ADJ/NOPB	LM386N-1/NOPB	LMC6484AIN/NOPB
LF412CN/NOPB	LM2674N-5.0/NOPB	LM386N-3/NOPB	LMC6484IN/NOPB
LM2574HVN-12/NOPB	LM2674N-ADJ/NOPB	LM386N-4/NOPB	LMC660AIN/NOPB
LM2574HVN-15/NOPB	LM2675N-12/NOPB	LM4562NA/NOPB	LMC660CN/NOPB
LM2574HVN-5.0/NOPB	LM2675N-5.0/NOPB	LM6134BIN/NOPB	LMC7660IN/NOPB
LM2574HVN-ADJ/NOPB	LM2675N-ADJ/NOPB	LM6144BIN/NOPB	LME49720NA/NOPB
LM2574N-12/NOPB	LM2901N/NOPB	LM833N/NOPB	<b>DS3668N / NOPB</b>
LM2574N-3.3/NOPB	LM2904N/NOPB	LMC6041IN/NOPB	
LM2574N-5.0/NOPB	LM311N/NOPB	LMC6042AIN/NOPB	

**Group 2 Product Affected:**

LF347BN/NOPB	LM2594N-5.0/NOPB	LM2907N-8/NOPB	LMC555CN/NOPB
LF347N/NOPB	LM2594N-ADJ/NOPB	LM2917N-8/NOPB	LMC6001AIN/NOPB
LF356N/NOPB	LM2597HVN-12/NOPB	LM331AN/NOPB	LMC6001BIN/NOPB
LF412ACN/NOPB	LM2597HVN-3.3/NOPB	LM331N/NOPB	LMC6032IN/NOPB
LF444ACN/NOPB	LM2597HVN-5.0/NOPB	LM358AN/NOPB	LMC6062IN/NOPB
LF444CN/NOPB	LM2597HVN-ADJ/NOPB	LM380N-8/NOPB	LMC6081IN/NOPB
LM10CLN/NOPB	LM2597N-12/NOPB	LM392N/NOPB	LMC6082AIN/NOPB
LM10CN/NOPB	LM2597N-3.3/NOPB	LM393N/NOPB	LMC6082IN/NOPB
LM1458N/NOPB	LM2597N-5.0/NOPB	LM5021NA-1/NOPB	LMC6442IN/NOPB
LM1949N/NOPB	LM2597N-ADJ/NOPB	LM555CN/NOPB	LMC6482IN/NOPB
LM231AN/NOPB	LM2671N-12/NOPB	LM567CN/NOPB	LMC662AIN/NOPB
LM231N/NOPB	LM2671N-3.3/NOPB	LM6132BIN/NOPB	LMC662CN/NOPB
LM2594HVN-12/NOPB	LM2672N-3.3/NOPB	LM6142BIN/NOPB	LP2951ACN/NOPB
LM2594HVN-3.3/NOPB	LM2674N-3.3/NOPB	LM6171BIN/NOPB	LP2951CN/NOPB
LM2594HVN-5.0/NOPB	LM2675N-3.3/NOPB	LM6172IN/NOPB	TL082CP/NOPB
LM2594HVN-ADJ/NOPB	LM2903N/NOPB	LM7171BIN/NOPB	
LM2594N-12/NOPB	LM2904N/S5000653	LM741CN/NOPB	
LM2594N-3.3/NOPB	LM2904N/SL161997	LM741CN/S7001461	

## Group 1 Qualification Report

Approve Date 05-Aug-2021

### Qualification Results

Data Displayed as: Number of lots / Total sample size / Total failed

Type	Test Name / Condition	Duration	Qual Device: <u>ADC0832CCN/N</u> <u>OPB</u>	Qual Device: <u>DS3668N/NO</u> <u>PB</u>	Qual Device: <u>LM6134BIN/N</u> <u>OPB</u>	QBS Package Referenc e: <u>LM2594HV</u> <u>N-</u> <u>ADJ/NOP</u> <u>B</u>	QBS Package Referenc e: <u>SN74HC59</u> <u>5N</u>	QBS Package Referenc e: <u>SN74LS03</u> <u>N</u>
AC	Autoclave 121C	96 Hours	3/231/0	3/231/0	3/231/0	3/231/0	3/225/0	3/231/0
ED	Electrical Characterization, side by side	-	Pass	Pass	Pass	Pass	Pass	-
HAST	Biased HAST, 130C/85%RH	96 Hours	-	-	-	3/231/0	-	-
HTSL	High Temp Storage Bake 170C	420 Hours	3/231/0	3/231/0	3/231/0	3/231/0	3/231/0	3/231/0
LI	Lead Fatigue	Leads	1/15/0	3/27/0	3/54/0	3/36/0	3/45/0	3/45/0
LI	Lead Pull	Leads	1/20/0	3/144/0	3/126/0	3/72/0	3/144/0	3/126/0
MQ	Manufacturability (Assembly)	(per mfg. Site specification)	Pass	Pass	Pass	Pass	Pass	Pass
PD	Physical Dimensions	(per mechanical drawing)	3/15/0	3/15/0	3/15/0	3/15/0	-	-
PKG	Lead Finish	Leads	-	3/45/0	-	-	3/45/0	3/45/0

Type	Test Name / Condition	Duration	Qual Device: <u>ADC0832CCN/N</u> <u>OPB</u>	Qual Device: <u>DS3668N/NO</u> <u>PB</u>	Qual Device: <u>LM6134BIN/N</u> <u>OPB</u>	QBS Package Referenc e: <u>LM2594HV</u> <u>N-</u> <u>ADJ/NOP</u> <u>B</u>	QBS Package Referenc e: <u>SN74HC59</u> <u>5N</u>	QBS Package Referenc e: <u>SN74LS03</u> <u>N</u>
	Adhesion							
SD	Solderability	Pb free	3/66/0	3/66/0	3/66/0	-	3/66/0	3/66/0
TC	Temperature Cycle, -65/150C	500 Cycles	3/231/0	3/231/0	3/231/0	3/231/0	3/231/0	3/231/0
VM	Visual/Mechanical	-	3/984/0	3/984/0	3/984/0	3/984/0	3/984/0	3/984/0
WBP	Bond Pull	Wires	3/228/0	3/228/0	3/228/0	3/228/0	3/228/0	3/228/0
WBS	Ball Bond Shear	Wires	3/228/0	3/228/0	3/228/0	3/228/0	3/228/0	3/228/0

- QBS: Qual By Similarity

- Qual Devices ADC0832CCN/NOPB, DS3668N/NOPB, LM6134BIN/NOPB are qualified at LEVEL1-NACG

- Device LM6134BIN/NOPB contains multiple dies.

- Preconditioning was performed for Autoclave, Unbiased HAST, THB/Biased HAST, Temperature Cycle, Thermal Shock, and HTSL, as applicable

- The following are equivalent HTOL options based on an activation energy of 0.7eV : 125C/1k Hours, 140C/480 Hours, 150C/300 Hours, and 155C/240 Hours

- The following are equivalent HTSL options based on an activation energy of 0.7eV : 150C/1k Hours, and 170C/420 Hours

- The following are equivalent Temp Cycle options per JESD47 : -55C/125C/700 Cycles and -65C/150C/500 Cycles

Quality and Environmental data is available at TI's external Web site: <http://www.ti.com/>

Green/Pb-free Status:

Qualified Pb-Free and Green

## Qualification Report

Approve Date 05-Aug-2021

### Qualification Results

Data Displayed as: Number of lots / Total sample size / Total failed

Type	Test Name / Condition	Duration	Qual Device: <u>ADC0832CCN/NOP</u> <u>B</u>	Qual Device: <u>LM6134BIN/NOP</u> <u>B</u>	QBS Package Reference: <u>LM2594HVN</u> <u>-ADJ/NOPB</u>	QBS Package Reference: <u>SN74HC595</u> <u>N</u>	QBS Package Reference : <u>SN74LS03N</u>
AC	Autoclave 121C	96 Hours	3/231/0	3/231/0	3/231/0	3/225/0	3/231/0
ED	Electrical Characterization	Per Datasheet Parameters	Pass	Pass	Pass	Pass	-
HAST	Biased HAST, 130C/85%RH	96 Hours	-	-	3/231/0	-	-
HTSL	High Temp Storage Bake 170C	420 Hours	3/231/0	3/231/0	3/231/0	3/231/0	3/231/0
LI	Lead Fatigue	Leads	1/15/0	3/54/0	3/36/0	3/45/0	3/45/0
LI	Lead Pull	Leads	1/20/0	3/72/0	3/72/0	3/72/0	3/72/0
PD	Physical Dimensions	(per mechanical drawing)	3/15/0	3/15/0	3/15/0	-	-
PKG	Lead Finish Adhesion	Leads	-	-	-	3/45/0	3/45/0
SD	Solderability	Pb free	3/66/0	3/66/0	-	3/66/0	3/66/0
TC	Temperature Cycle, -65/150C	500 Cycles	3/231/0	3/231/0	3/231/0	3/231/0	3/231/0
VM	Visual /	(per mfg.)	3/984/0	3/984/0	3/984/0	3/984/0	3/984/0

Type	Test Name / Condition	Duration	Qual Device: <u>ADC0832CCN/NOPB</u> B	Qual Device: <u>LM6134BIN/NOPB</u> B	QBS Package Reference: <u>LM2594HVN-ADJ/NOPB</u>	QBS Package Reference: <u>SN74HC595N</u>	QBS Package Reference: : <u>SN74LS03N</u>
	Mechanical	Site specification )					
WBP	Bond Pull	Wires	3/228/0	3/228/0	3/228/0	3/228/0	3/228/0
WBS	Ball Bond Shear	Wires	3/228/0	3/228/0	3/228/0	3/228/0	3/228/0

- QBS: Qual By Similarity

- Qual Devices ADC0832CCN/NOPB and LM6134BIN/NOPB are qualified at LEVEL1-NACG

- Device LM6134BIN/NOPB contains multiple dies.

- Preconditioning was performed for Autoclave, Unbiased HAST, THB/Biased HAST, Temperature Cycle, Thermal Shock, and HTSL, as applicable

- The following are equivalent HTOL options based on an activation energy of 0.7eV : 125C/1k Hours, 140C/480 Hours, 150C/300 Hours, and 155C/240 Hours

- The following are equivalent HTSL options based on an activation energy of 0.7eV : 150C/1k Hours, and 170C/420 Hours

- The following are equivalent Temp Cycle options per JESD47 : -55C/125C/700 Cycles and -65C/150C/500 Cycles

Quality and Environmental data is available at TI's external Web site: <http://www.ti.com/>

**Green/Pb-free Status:**

Qualified Pb-Free and Green

## Group 2 Qualification Report

Approve Date 05-Aug-2021

### Qualification Results

Data Displayed as: Number of lots / Total sample size / Total failed

Type	Test Name / Condition	Duration	Qual Device: <u>LF444ACN/NOPB</u> PB	Qual Device: <u>LM231AN/NOPB</u> PB	Qual Device: <u>LM2594HVN-ADJ/NOPB</u>	Qual Device: <u>LMC6482IN/NOPB</u>	QBS Package Reference: <u>SN74HC595N</u>	QBS Package Reference: <u>SN74LS03N</u>
AC	Autoclave 121C	96 Hours	3/231/0	3/231/0	3/231/0	3/231/0	3/225/0	3/231/0
ED	Electrical Characterization	Per Datasheet Parameters	Pass	Pass	Pass	Pass	Pass	-
HAST	Biased HAST, 130C/85%RH	96 Hours	-	-	3/231/0	-	-	-
HTSL	High Temp Storage Bake 170C	420 Hours	3/231/0	3/231/0	3/231/0	3/231/0	3/231/0	3/231/0
LI	Lead Fatigue	Leads	3/27/0	3/54/0	3/36/0	3/54/0	3/45/0	3/45/0
LI	Lead Pull	Leads	3/72/0	3/72/0	3/72/0	3/72/0	3/72/0	3/72/0
PD	Physical Dimensions	(per mechanical drawing)	3/15/0	3/15/0	3/15/0	3/15/0	3/15/0	3/15/0
PKG	Lead Finish Adhesion	Leads	3/45/0	-	-	-	3/45/0	3/45/0
SD	Solderability	Pb Free	3/66/0	3/66/0	-	3/66/0	3/66/0	3/66/0
TC	Temperature Cycle, -65/150C	500 Cycles	3/231/0	3/231/0	3/231/0	3/231/0	3/231/0	3/231/0
VM	Visual / Mechanical	(per mfg. Site)	3/984/0	3/984/0	3/984/0	3/984/0	3/984/0	3/984/0



Type	Test Name / Condition	Duration	Qual Device: <u>LF444ACN/NO</u> <u>PB</u>	Qual Device: <u>LM231AN/NO</u> <u>PB</u>	Qual Device: <u>LM2594HV</u> <u>N-</u> <u>ADJ/NOPB</u>	Qual Device: <u>LMC6482IN/NO</u> <u>PB</u>	QBS Package Reference: <u>SN74HC59</u> <u>5N</u>	QBS Package Reference: <u>SN74LS03</u> <u>N</u>
		specification)						
WBP	Bond Pull	Wires	3/228/0	3/228/0	3/228/0	3/228/0	3/228/0	3/228/0
WBS	Ball Bond Shear	Wires	3/228/0	3/228/0	3/228/0	3/228/0	3/228/0	3/228/0

- QBS: Qual By Similarity

- Qual Devices LF444ACN/NOPB, LM231AN/NOPB, LM2594HV-N-ADJ/NOPB, LMC6482IN/NOPB is qualified at LEVEL1-NACG

- Preconditioning was performed for Autoclave, Unbiased HAST, THB/Biased HAST, Temperature Cycle, Thermal Shock, and HTSL, as applicable

- The following are equivalent HTOL options based on an activation energy of 0.7eV : 125C/1k Hours, 140C/480 Hours, 150C/300 Hours, and 155C/240 Hours

- The following are equivalent HTSL options based on an activation energy of 0.7eV : 150C/1k Hours, and 170C/420 Hours

- The following are equivalent Temp Cycle options per JESD47 : -55C/125C/700 Cycles and -65C/150C/500 Cycles

Quality and Environmental data is available at TI's external Web site: <http://www.ti.com/>

**Green/Pb-free Status:**

Qualified Pb-Free and Green

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	<a href="mailto:PCNAmericasContact@list.ti.com">PCNAmericasContact@list.ti.com</a>
Europe	<a href="mailto:PCNEuropeContact@list.ti.com">PCNEuropeContact@list.ti.com</a>
Asia Pacific	<a href="mailto:PCNAsiaContact@list.ti.com">PCNAsiaContact@list.ti.com</a>
Japan	<a href="mailto:PCNJapanContact@list.ti.com">PCNJapanContact@list.ti.com</a>

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